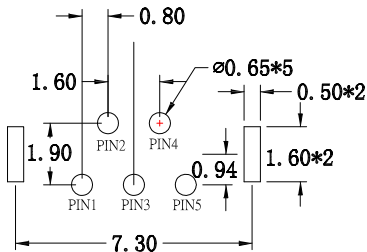
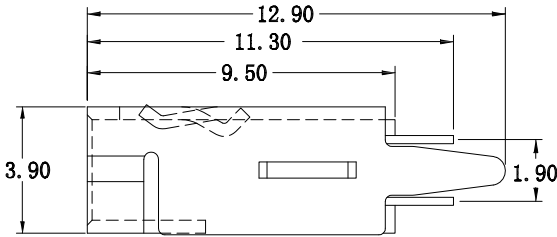
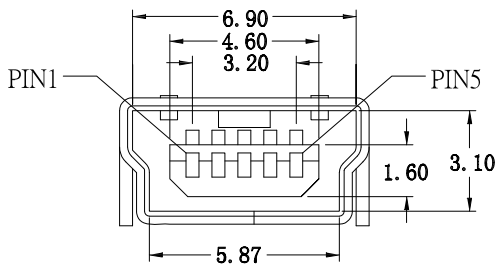
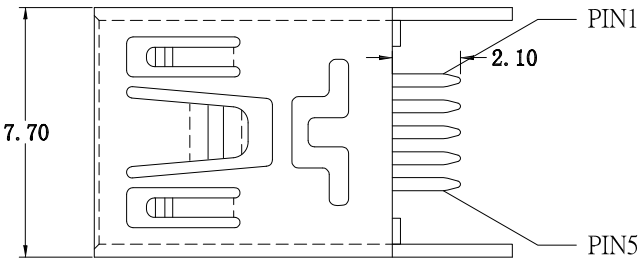




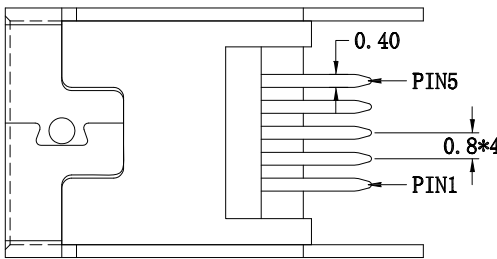
MUSB-5B-VD-x-S175

鍍層厚度 :

Blank : 1u"
2 : 15u"
3 : 30u"



P.C.B LAYOUT MOUNTING PATTERN



SPECIFICATIONS

Electrical :

- 1.Current Rating : 1.0A / contact terminal
- 2.Voltage Rating : 30V DC
- 3.Contact Resistance : 50 mΩ Max
- 4.Dielectric Withstanding Voltage : 300 V AC AT Sec Level
- 5.Insulation Resistance : 100 MΩ Min

Mechanical :

- 1.Connector Mate and Unmate Force
 - Mate force : 3.0 kgf (Max)
 - Unmate force : 0.7 kgf (Min)
- 2.Terminal Retention : 0.5 kgf (Min)

Material :

- 1.Housing : High Temperature Thermal Plastics, UL 94V-0 , LCP , Black
- 2.Contact : PHOSPHOR BRONZE
- 3.Shell : BRASS

Finish :

- 1.Contact : Plated Gold in Mating Area ; Tin Plated on Solder Balls ; Nickel under plated overall
- 2.Shell : Nickel under Plated surface layer

				CONTACT 建倚科技股份有限公司 CONTACT TECHNOLOGY CORP. TOLERANCE UNLESS OTHERWISE STATED : Up to 5 ± 0.2 Above 5 ~ 15 ± 0.3 Above 15 ~ 30 ± 0.4 Above 30 ~ 50 ± 0.5 Angle ± 0.3° 3RD. ANGEL'S  UNIT'S MM					DRAWN BY:	DATE	MAT'L		TITLE	CONNECTOR	
4	更新CONTACT材質	Jack	022725						CHECKED BY:	DATE	FINISH		MODLE	MINI USB 5B/F 180 度 DIP 直插腳	
3	更新為A0版	Jack	031317	Jacky Chen	02/27/25	SCALE	1 : 1	DWG NO.	MUSB-5B-VD-x-S175	SIZE					
2	更新鍍層	Jack	020717	APPROVED BY:	DATE	SHEET NO.	1 of 1	PART NO.	MUSB-5B-VD-x-S175	A4					
1	新增PIN標示	Jack	120216	Tony Kao	02/27/25					VER					
ITEM NO.	DESCRIPTION	DRAWN	DATE							R4					